intel®

MCS®-51
8-BIT CONTROL-ORIENTED MICROCOMPUTERS
8031/8051
8031AH/8051AH
8032AH/8052AH
8751H/8751H-8

- High Performance HMOS Process
- Internal Timers/Event Counters
- 2-Level Interrupt Priority Structure
- 32 I/O Lines (Four 8-Bit Ports)
- 64K Program Memory Space
- Security Feature Protects EPROM Parts Against Software Piracy

- Boolean Processor
- Bit-Addressable RAM
- Programmable Full Duplex Serial Channel
- 111 Instructions (64 Single-Cycle)
- 64K Data Memory Space

The MCS®-51 products are optimized for control applications. Byte-processing and numerical operations on small data structures are facilitated by a variety of fast addressing modes for accessing the internal RAM. The instruction set provides a convenient menu of 8-bit arithmetic instructions, including multiply and divide instructions. Extensive on-chip support is provided for one-bit variables as a separate data type, allowing direct bit manipulation and testing in control and logic systems that require Boolean processing.

The 8051 is the original member of the MCS-51 family. The 8051AH is identical to the 8051, but it is fabricated with HMOS II technology.

The 8751H is an EPROM version of the 8051AH; that is, the on-chip Program Memory can be electrically programmed, and can be erased by exposure to ultraviolet light. It is fully compatible with its predecessor, the 8751-8, but incorporates two new features: a Program Memory Security bit that can be used to protect the EPROM against unauthorized read-out, and a programmable baud rate modification bit (SMOD). The 8751H-8 is identical to the 8751H but only operates up to 8 MHz.

The 8052AH is an enhanced version of the 8051AH. It is backwards compatible with the 8051AH and is fabricated with HMOS II technology. The 8052AH enhancements are listed in the table below. Also refer to this table for the ROM, ROMless, and EPROM versions of each product.

Device	Internal Memory		Timers/ Event Counters	Interrupts
	Program	Data		
8052AH	8K x 8 ROM	256 x 8 RAM	3 x 16-Bit	6
8051AH	4K x 8 ROM	128 x 8 RAM	2 x 16-Bit	5
8051	4K x 8 ROM	128 x 8 RAM	2 x 16-Bit	5
8032AH	none	256 x 8 RAM	3 x 16-Bit	6
8031AH	none	128 x 8 RAM	2 x 16-Bit	5
8031	none	128 x 8 RAM	2 x 16-Bit	5
8751H	4K x 8 EPROM	128 x 8 RAM	2 x 16-Bit	5
8751H-8	4K x 8 EPROM	128 x 8 RAM	2 x 16-Bit	5

intel   MCS®-51   PRELIMINARY
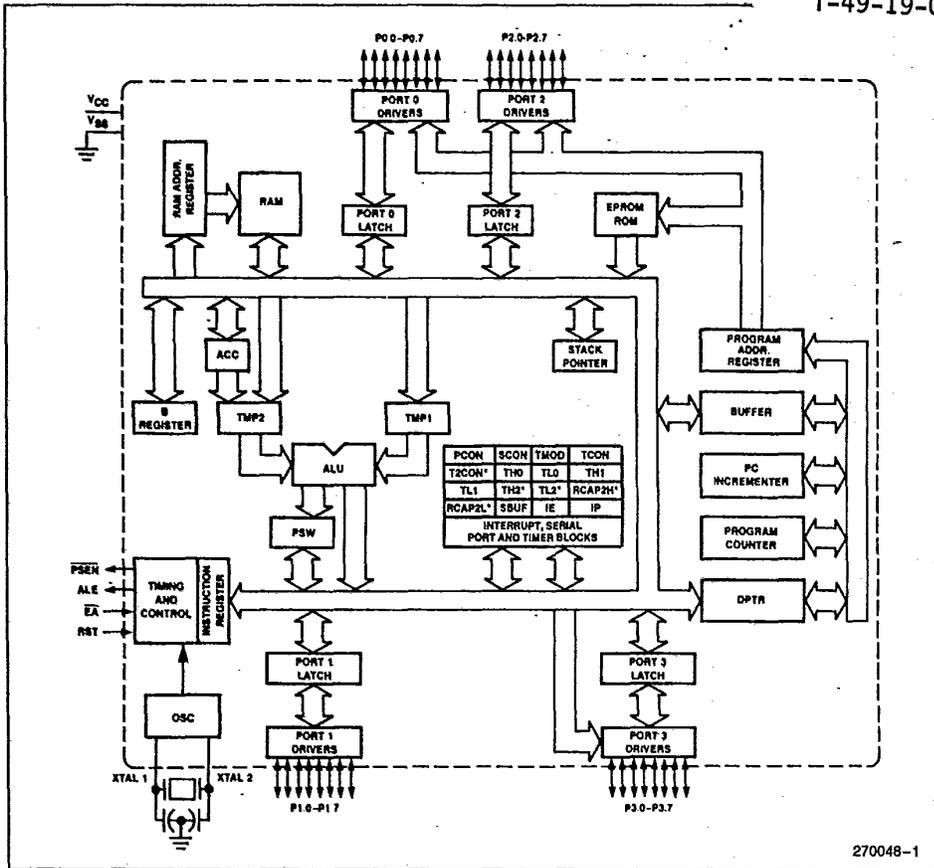
Figure 1. MCS®-51 Block Diagram

PACKAGES

Part	Prefix	Package Type
8051AH/	P	40-Pin Plastic DIP
8031AH	D	40-Pin CERDIP
	N	44-Pin PLCC
8052AH/	P	40-Pin Plastic DIP
8032AH	D	40-Pin CERDIP
	N	44-Pin PLCC
8751H/	D	40-Pin CERDIP
8751H-8	R	44-Pin LCC

PIN DESCRIPTIONS

V_{CC}: Supply voltage.

V_{SS}: Circuit ground.

Port 0: Port 0 is an 8-bit open drain bidirectional I/O port. As an output port each pin can sink 8 LS TTL inputs.

Port 0 pins that have 1s written to them float, and in that state can be used as high-impedance inputs.

Port 0 is also the multiplexed low-order address and data bus during accesses to external Program and Data Memory. In this application it uses strong internal pullups when emitting 1s and can source and sink 8 LS TTL inputs.

Port 0 also receives the code bytes during programming of the EPROM parts, and outputs the code bytes during program verification of the ROM and EPROM parts. External pullups are required during program verification.
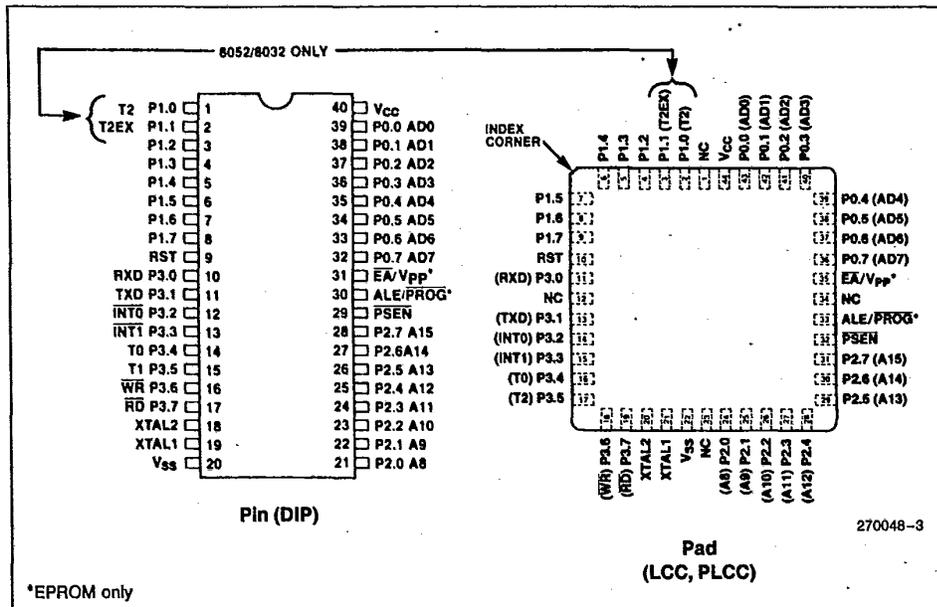
Figure 2. MCS®-51 Connections

Port 1: Port 1 is an 8-bit bidirectional I/O port with internal pullups. The Port 1 output buffers can sink/source 4 LS TTL inputs. Port 1 pins that have 1s written to them are pulled high by the internal pull-ups, and in that state can be used as inputs. As inputs, Port 1 pins that are externally being pulled low will source current (I_{IL} on the data sheet) because of the internal pullups.

Port 1 also receives the low-order address bytes during programming of the EPROM parts and during program verification of the ROM and EPROM parts.

In the 8032AH and 8052AH, Port 1 pins P1.0 and P1.1 also serve the T2 and T2EX functions, respectively.

Port 2: Port 2 is an 8-bit bidirectional I/O port with internal pullups. The Port 2 output buffers can sink/source 4 LS TTL inputs. Port 2 pins that have 1s written to them are pulled high by the internal pull-ups, and in that state can be used as inputs. As inputs, Port 2 pins that are externally being pulled low will source current (I_{IL} on the data sheet) because of the internal pullups.

Port 2 emits the high-order address byte during fetches from external Program Memory and during accesses to external Data Memory that use 16-bit addresses (MOVX @DPTR). In this application it uses strong internal pullups when emitting 1s. Dur-

ing accesses to external Data Memory that use 8-bit addresses (MOVX @Ri), Port 2 emits the contents of the P2 Special Function Register.

Port 2 also receives the high-order address bits during programming of the EPROM parts and during program verification of the ROM and EPROM parts.

Port 3: Port 3 is an 8-bit bidirectional I/O port with internal pullups. The Port 3 output buffers can sink/source 4 LS TTL inputs. Port 3 pins that have 1s written to them are pulled high by the internal pull-ups, and in that state can be used as inputs. As inputs, Port 3 pins that are externally being pulled low will source current (I_{IL} on the data sheet) because of the pullups.

Port 3 also serves the functions of various special features of the MCS-51 Family, as listed below:

Port Pin	Alternative Function
P3.0	RXD (serial input port)
P3.1	TXD (serial output port)
P3.2	INT0 (external interrupt 0)
P3.3	INT1 (external interrupt 1)
P3.4	T0 (Timer 0 external input)
P3.5	T1 (Timer 1 external input)
P3.6	WR (external data memory write strobe)
P3.7	RD (external data memory read strobe)

RST: Reset input. A high on this pin for two machine cycles while the oscillator is running resets the device.

ALE/$\overline{PROG}$: Address Latch Enable output pulse for latching the low byte of the address during accesses to external memory. This pin is also the program pulse input ($\overline{PROG}$) during programming of the EPROM parts.

In normal operation ALE is emitted at a constant rate of $\frac{1}{6}$ the oscillator frequency, and may be used for external timing or clocking purposes. Note, however, that one ALE pulse is skipped during each access to external Data Memory.

$\overline{PSEN}$: Program Store Enable is the read strobe to external Program Memory.

When the device is executing code from external Program Memory, $\overline{PSEN}$ is activated twice each machine cycle, except that two $\overline{PSEN}$ activations are skipped during each access to external Data Memory.

$\overline{EA}$/V$_{PP}$: External Access enable $\overline{EA}$ must be strapped to V$_{SS}$ in order to enable any MCS-51 device to fetch code from external Program memory locations starting at 0000H up to FFFFH. $\overline{EA}$ must be strapped to V$_{CC}$ for internal program execution.

Note, however, that if the Security Bit in the EPROM devices is programmed, the device will not fetch code from any location in external Program Memory.

This pin also receives the 21V programming supply voltage (VPP) during programming of the EPROM parts.

C1, C2 = 30 pF ± 10 pF for Crystals
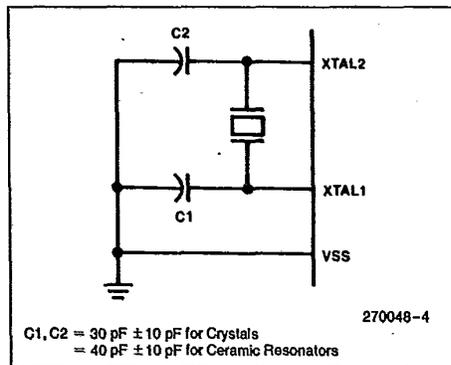= 40 pF ± 10 pF for Ceramic Resonators

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Figure 3. Oscillator Connections

XTAL1: Input to the inverting oscillator amplifier.

XTAL2: Output from the inverting oscillator amplifier.

OSCILLATOR CHARACTERISTICS

XTAL1 and XTAL2 are the input and output, respectively, of an inverting amplifier which can be configured for use as an on-chip oscillator, as shown in Figure 3. Either a quartz crystal or ceramic resonator may be used. More detailed information concerning the use of the on-chip oscillator is available in Application Note AP-155, "Oscillators for Microcontrollers."

To drive the device from an external clock source, XTAL1 should be grounded, while XTAL2 is driven, as shown in Figure 4. There are no requirements on the duty cycle of the external clock signal, since the input to the internal clocking circuitry is through a divide-by-two flip-flop, but minimum and maximum high and low times specified on the Data Sheet must be observed.
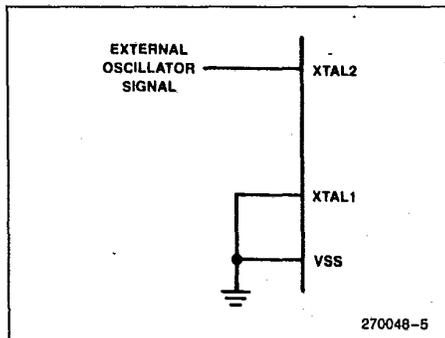

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Figure 4. External Drive Configuration

DESIGN CONSIDERATIONS

If an 8751BH or 8752BH may replace an 8751H in a future design, the user should carefully compare both data sheets for DC or AC Characteristic differences. Note that the V$_{IH}$ and I$_{IH}$ specifications for the $\overline{EA}$ pin differ significantly between the devices.

Exposure to light when the EPROM device is in operation may cause logic errors. For this reason, it is suggested that an opaque label be placed over the window when the die is exposed to ambient light.

ABSOLUTE MAXIMUM RATINGS*

Ambient Temperature Under Bias ......0°C to 70°C
Storage Temperature .... −65°C to +150°C
Voltage on $\overline{EA}$/V$_{PP}$ Pin to V$_{SS}$ ... −0.5V to +21.5V
Voltage on Any Other Pin to V$_{SS}$ .... −0.5V to +7V
Power Dissipation........................1.5W

*Notice: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

D.C. CHARACTERISTICS T_A = 0°C to 70°C; V_{CC} = 5V ±10%; V_{SS} = 0V

Symbol	Parameter		Min	Max	Units	Test Conditions
V_{IL}	Input Low Voltage (Except $\overline{EA}$ Pin of 8751H & 8751H-8)		−0.5	0.8	V	
V_{IL1}	Input Low Voltage to $\overline{EA}$ Pin of 8751H & 8751H-8		0	0.7	V	
V_{IH}	Input High Voltage (Except XTAL2, RST)		2.0	V_{CC} + 0.5	V	
V_{IH1}	Input High Voltage to XTAL2, RST		2.5	V_{CC} + 0.5	V	XTAL1 = V_{SS}
V_{OL}	Output Low Voltage (Ports 1, 2, 3)*			0.45	V	I_{OL} = 1.6 mA
V_{OL1}	Output Low Voltage (Port 0, ALE, $\overline{PSEN}$)*					
		8751H, 8751H-8		0.60	V	I_{OL} = 3.2 mA
				0.45	V	I_{OL} = 2.4 mA
		All Others		0.45		I_{OL} = 3.2 mA
V_{OH}	Output High Voltage (Ports 1, 2, 3, ALE, $\overline{PSEN}$)		2.4		V	I_{OH} = −80 μA
V_{OH1}	Output High Voltage (Port 0 in External Bus Mode)		2.4		V	I_{OH} = −400 μA
I_{IL}	Logical 0 Input Current (Ports 1, 2, 3, RST) 8032AH, 8052AH			−800	μA	V_{IN} = 0.45V
	All Others			−500	μA	V_{IN} = 0.45V
I_{IL1}	Logical 0 Input Current to $\overline{EA}$ Pin of 8751H & 8751H-8 Only			−15	mA	V_{IN} = 0.45V
I_{IL2}	Logical 0 Input Current (XTAL2)			−3.2	mA	V_{IN} = 0.45V
I_{LI}	Input Leakage Current (Port 0) 8751H & 8751H-8			±100	μA	$0.45 \leq V_{IN} \leq V_{CC}$
	All Others			±10	μA	$0.45 \leq V_{IN} \leq V_{CC}$
I_{IH}	Logical 1 Input Current to $\overline{EA}$ Pin of 8751H & 8751H-8			500	μA	V_{IN} = 2.4V
I_{IH1}	Input Current to RST to Activate Reset			500	μA	$V_{IN} < (V_{CC} − 1.5V)$
I_{CC}	Power Supply Current: 8031/8051			160	mA	
	8031AH/8051AH			125	mA	All Outputs
	8032AH/8052AH			175	mA	Disconnected;
	8751H/8751H-8			250	mA	$\overline{EA}$ = V_{CC}
C_{IO}	Pin Capacitance			10	pF	Test freq = 1 MHz

*NOTE:
Capacitive loading on Ports 0 and 2 may cause spurious noise pulses to be superimposed on the V$_{OL}$s of ALE and Ports 1 and 3. The noise is due to external bus capacitance discharging into the Port 0 and Port 2 pins when these pins make 1-to-0 transitions during bus operations. In the worst cases (capacitive loading > 100 pF), the noise pulse on the ALE line may exceed 0.8V. In such cases it may be desirable to qualify ALE with a Schmitt Trigger, or use an address latch with a Schmitt Trigger STROBE input.

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